MDTE Series

Wire Wound Molded SMD Power Inductors

Size 1030



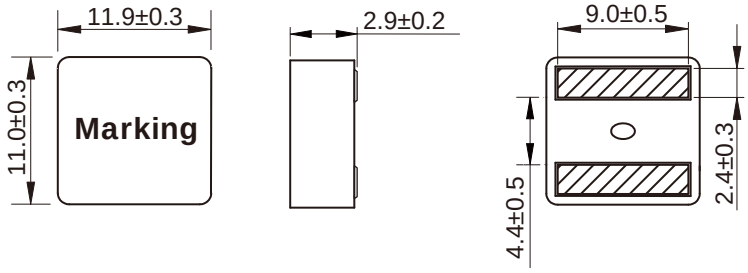
FEATURES

- So satura on
- High current,low DCR,high e ciency
- Very low acous c noise and very low leakage flux noise
- High reliability
- 100% Lead(Pb)-Free and RoHS compliant
- Opera ng temperature -55~+125℃(Including self - temperature rise)
- Quan ty: 1000pcs

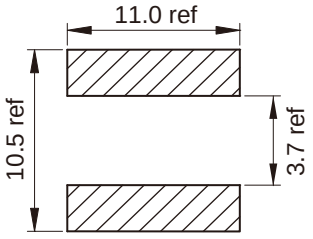
APPLICATION

- Note PC power system,incl. IMVP-6
- DC/DC converter

Dimensions: [mm]



Land Pattern: [mm]



Electrical Properties:

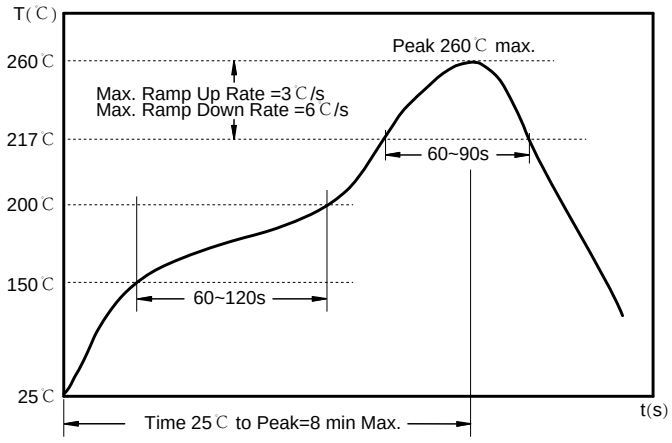
Part No	Inductance @ 100KHz/0.1V	Tolerance	Current Typ.	Current Max.	Temperature Rise Current Typ.	DC Resistance Max.
MDTE1030-R28M	0.28	±20%	65.0	58.0	35.0	1.60
MDTE1030-R56M	0.56	±20%	44.0	39.0	32.0	2.75
MDTE1030-R82M	0.82	±20%	38.0	32.0	25.0	4.10
MDTE1030-R90M	0.90	±20%	36.0	31.0	24.0	4.20
MDTE1030-1R0M	1.00	±20%	35.0	30.0	23.0	4.95
MDTE1030-1R5M	1.50	±20%	30.0	25.0	18.0	6.60

Saturation Current will cause L to drop approximately 30%

Temperature Rise Current: The actual value of DC current when the temperature rise is △T=40°C

KOHER Electronic
4546 BATES DRIVE, YORBLINDA CA 92886 USA
714-325-4789 Contact@kohergroup.com

Soldering Reflow:



Preheat condition: 150 ~200℃/ 60~120 sec.

Allowed time above 217℃: 60~90 sec.

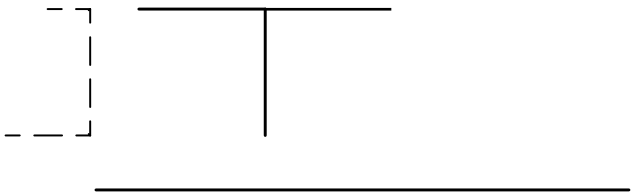
Max temperature: 260℃.

Max time at max temperature: 10 sec.

Allowed Reflow time: 2x max.

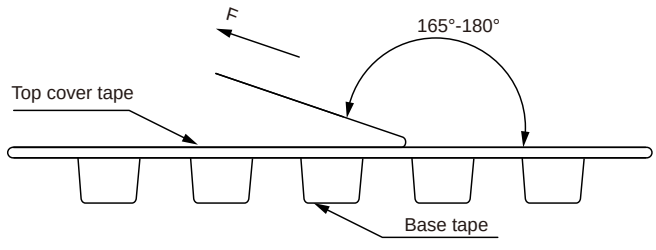
Packaging Information:

Tape Dimension:



Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
MDTE1030	12.4±0.1	11.5±0.1	1.5±0.1	4.0±0.1	16.0±0.1	24.0±0.3	3.3±0.1	1.75±0.1	0.35±0.05

Peel force of top cover tape:



The peel force of top cover tape shall be between 0.1 to 1.3 N

Product Marking:

Marking	Printing (Inductance)

Reel Dimension：[mm]



Packaging Quantity: